

# **MOSFET** – Power, for 1-Cell Lithium-ion Battery Protection, Dual N-Channel

12 V, 13 A, 9.0 m $\Omega$ 

# **EFC6604R**

This Power MOSFET features a low on-state resistance. This device is suitable for applications such as power switches of portable machines. Best suited for 1-cell lithium-ion battery applications.

#### **Features**

- 2.5 V Drive
- 2 kV ESD HBM
- Common-Drain Type
- ESD Diode-Protected Gate
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

#### **Applications**

• 1-Cell Lithium-ion Battery Charging and Discharging Switch

## **Specifications**

# **ABSOLUTE MAXIMUM RATINGS** (T<sub>A</sub> = 25°C)

Parameter	Symbol	Value	Unit
Source-to-Source Voltage	V <sub>SSS</sub>	12	V
Gate-to-Source Voltage	$V_{GSS}$	±12	V
Source Current (DC)	IS	13	Α
Source Current (Pulse) PW $\leq$ 10 $\mu$ s, duty cycle $\leq$ 1%	I <sub>SP</sub>	60	Α
Total Dissipation (Note 1)	P <sub>T</sub>	1.6	W
Junction Temperature	$T_{J}$	150	°C
Storage Temperature	T <sub>STG</sub>	– 55 to +150	°C

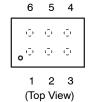
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

# THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Junction to Ambient (Note 1)	$R_{\theta JA}$	78.1	°C/W

1. Surface mounted on ceramic substrate (5000 mm<sup>2</sup> x 0.8 mm)

### **PIN ASSIGNMENT**



1: Source1

2: Gate1

3: Source1

4: Source2

5: Gate2

6: Source2

6: Source

V <sub>SSS</sub>	R <sub>SS(on)</sub> Max	I <sub>S</sub> Max
12 V	9.0 mΩ @ 4.5 V	13 A
	9.7 mΩ @ 4.0 V	
	10.0 mΩ @ 3.8 V	
	12.7 mΩ @ 3.1 V	
	17.7 mΩ @ 2.5 V	



WLCSP6 1.91x1.46 / EFCP1915-6CE-020 CASE 614AC

# **MARKING DIAGRAM**

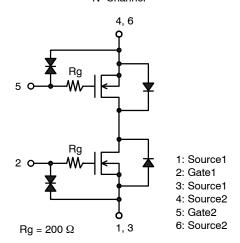
MD YMZZ

MD = Specific Device CodeY = Year of Production

M = Assembly Operation MonthZZ = Assembly Lot Number

#### **ELECTRICAL CONNECTION**

N-Channel



# **ORDERING INFORMATION**

Device	Package	Shipping
EFC6604R-TR	WLCSP6 (Pb-Free and Halogen Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# **ELECTRICAL CHARACTERISTICS** $(T_A = 25^{\circ}C)$

Parameter	Symbol	Condition	s	Min	Тур	Max	Unit
Source-to-Source Breakdown Voltage	V <sub>(BR)SSS</sub>	I <sub>S</sub> = 1 mA, V <sub>GS</sub> = 0 V	Test Circuit 1	12	-	_	V
Zero-Gate Voltage Source Current	I <sub>SSS</sub>	V <sub>SS</sub> = 10 V, V <sub>GS</sub> = 0 V	Test Circuit 1	-	-	1	μΑ
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{GS} = \pm 8 \text{ V}, V_{SS} = 0 \text{ V}$	Test Circuit 2	_	-	±1.0	μΑ
Gate Threshold Voltage	V <sub>GS</sub> (th)	V <sub>SS</sub> = 6 V, I <sub>S</sub> = 1 mA	Test Circuit 3	0.5	-	1.3	V
Forward Transconductance	9 <sub>FS</sub>	V <sub>SS</sub> = 6 V, I <sub>S</sub> = 3 A	Test Circuit 4	_	13.7	_	S
Static Source-to-Source On-State Resistance	R <sub>SS</sub> (on)1	I <sub>S</sub> = 3 A, V <sub>GS</sub> = 4.5 V	Test Circuit 5	6.0	7.5	9.0	mΩ
	R <sub>SS</sub> (on)2	I <sub>S</sub> = 3 A, V <sub>GS</sub> = 4.0 V	Test Circuit 5	6.4	8.1	9.7	mΩ
	R <sub>SS</sub> (on)3	I <sub>S</sub> = 3 A, V <sub>GS</sub> = 3.8 V	Test Circuit 5	6.7	8.4	10.0	mΩ
	R <sub>SS</sub> (on)4	I <sub>S</sub> = 3 A, V <sub>GS</sub> = 3.1 V	Test Circuit 5	7.8	9.8	12.7	mΩ
	R <sub>SS</sub> (on)5	I <sub>S</sub> = 3 A, V <sub>GS</sub> = 2.5 V	Test Circuit 5	10.0	12.6	17.7	mΩ
Turn-ON Delay Time	t <sub>d</sub> (on)	V <sub>SS</sub> = 6 V, V <sub>GS</sub> = 4.5 V,	Test Circuit 6	_	300	_	ns
Rise Time	t <sub>r</sub>	I <sub>S</sub> = 3 A		_	1200	-	ns
Turn-OFF Delay Time	t <sub>d</sub> (off)			_	5200	-	ns
Fall Time	t <sub>f</sub>			_	3900	-	ns
Total Gate Charge	Qg	V <sub>SS</sub> = 6 V, V <sub>GS</sub> = 4.5 V, I <sub>S</sub> = 13 A	Test Circuit 7	-	29	-	nC
Forward Source-to-Source Voltage	V <sub>F(S-S)</sub>	I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V	Test Circuit 8	-	0.75	1.2	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Test circuits are example of measuring FET1 side.

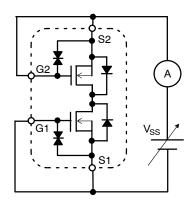
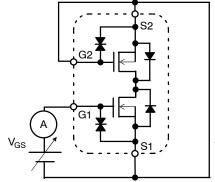


Figure 1. Test Circuit 1 –  $V_{SSS}$  /  $I_{SSS}$ 



When FET1 is measured, Gate and Source of FET2 are short-circuited.

Figure 2. Test Circuit 2 - I<sub>GSS</sub>

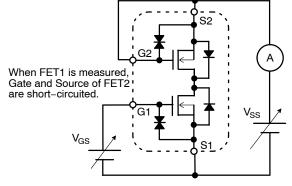


Figure 3. Test Circuit 3 - V<sub>GS</sub>(th)

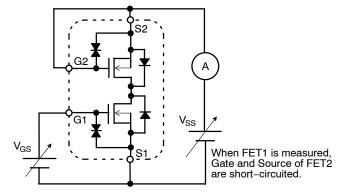
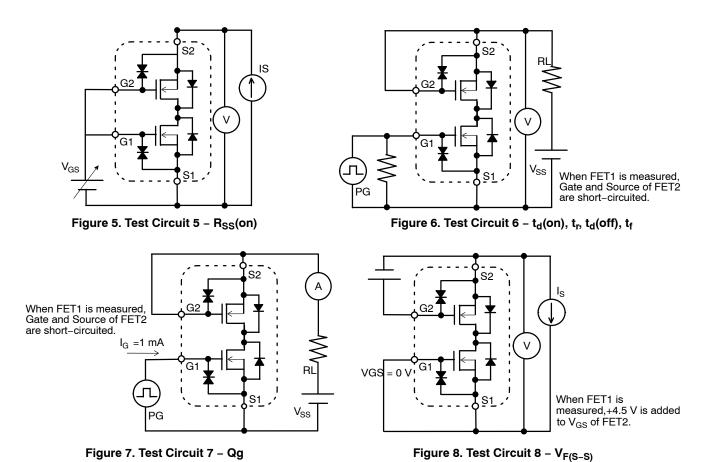


Figure 4. Test Circuit 4 - g<sub>FS</sub>

# **TEST CIRCUITS** (continued)



When FET2 is measured, the position of FET1 and FET2 is switched.  $\,$ 

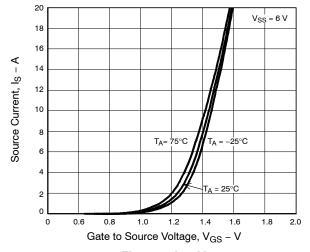


Figure 9. I<sub>S</sub> - V<sub>GS</sub>

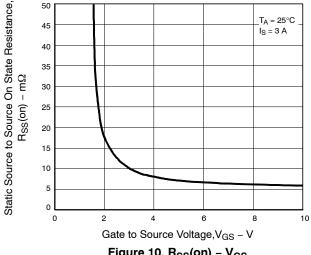


Figure 10. R<sub>SS</sub>(on) - V<sub>GS</sub>

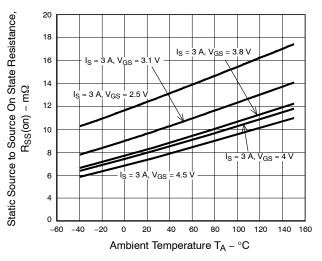


Figure 11. R<sub>SS</sub>(on) - T<sub>A</sub>

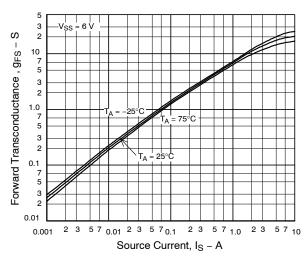


Figure 12. g<sub>FS</sub> - I<sub>S</sub>

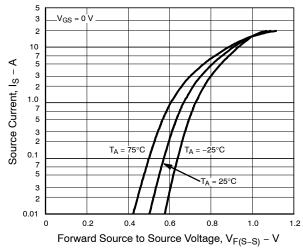


Figure 13. I<sub>S</sub> - V<sub>F(S-S)</sub>

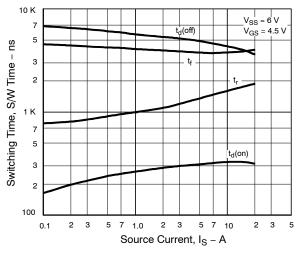


Figure 14. S/W Time –  $I_S$ 

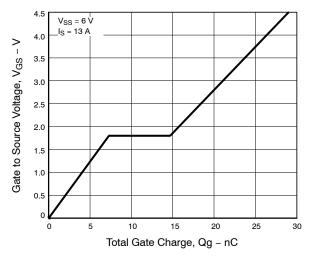


Figure 15. V<sub>GS</sub> - Qg

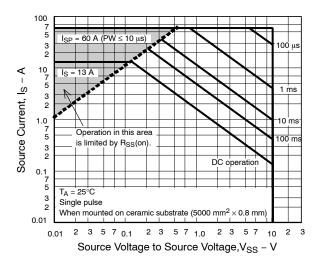


Figure 16. SOA

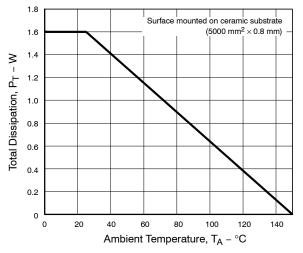


Figure 17. P<sub>T</sub> - T<sub>A</sub>

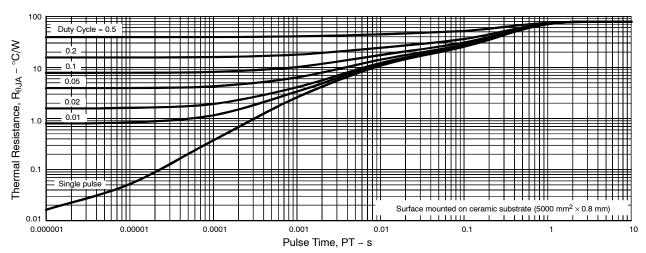


Figure 18.  $R_{\theta JA}$  – Pulse Time

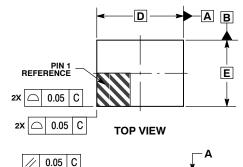
Note on usage: Since the EFC6604R is a MOSFET product, please avoid using this device in the vicinity of highly charged objects. Please contact sales for use except the designated application.

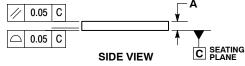


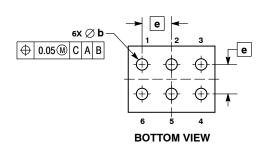


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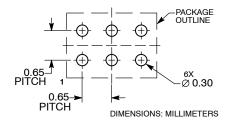


#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.18	0.22	
b	0.27	0.33	
D	1.91	BSC	
E	1.46 BSC		
е	0.65	BSC	

#### **RECOMMENDED SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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